

Patent Application No. 10/562,712
Attorney Docket No. 81872.0106
Customer No. 26021

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Nobuhiro HIGASHIHARA, et al.

Serial No: 10/562,712

Filed: December 23, 2005

For: PROCESS FOR PRODUCING METAL
PLATING FILM, PROCESS FOR
PRODUCING ELECTRONIC PART
AND PLATING FILM FORMING
APPARATUS

Art Unit: 1795

Examiner: Luan V. Van

Confirmation No.: 8642

RESPONSE TO RESTRICTION REQUIREMENT

Mail Stop AMENDMENT

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

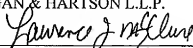
In response to the Restriction Requirement dated May 4, 2009, applicant elects for prosecution, Group I, Claims 1-14, drawn to method, and species iv, the method of attaching a dielectric slurry on to the metal plating film, Fig. 8 (claim 9). Claims 1-5, 9, 10 and 12-14 read on the elected species.

If there are any fees due in connection with the filing of this response, please charge the fees to our Deposit Account No. 50-1314.

Respectfully submitted,

HOGAN & HARTSON L.L.P.

By:


Lawrence J. McClure

Registration No. 44,228

Attorney for Applicant(s)

Date: June 3, 2009

1999 Avenue of the Stars, Suite 1400

Los Angeles, California 90067

Phone: (310) 785-4600

Fax: (310) 785-4601